

SILICON EPITAXIAL POWER TRANSISTORS

NPN silicon epitaxial power transistors, each in a SOT186 envelope with an electrically insulated mounting base.

PNP complements are BD944F, BD946F and BD948F.

QUICK REFERENCE DATA

		BD943F	945F	947F	
Collector-base voltage (open emitter)	V _{CBO}	max.	22	32	45 V
Collector-emitter voltage (open base)	V _{CEO}	max.	22	32	45 V
Emitter-base voltage (open collector)	V _{EBO}	max.		5	V
DC collector current	I _C	max.		5	A
Total power dissipation up to T _h = 25 °C	P _{tot}	max.	22		W

MECHANICAL DATA

Pinning

- 1 = base
- 2 = collector
- 3 = emitter

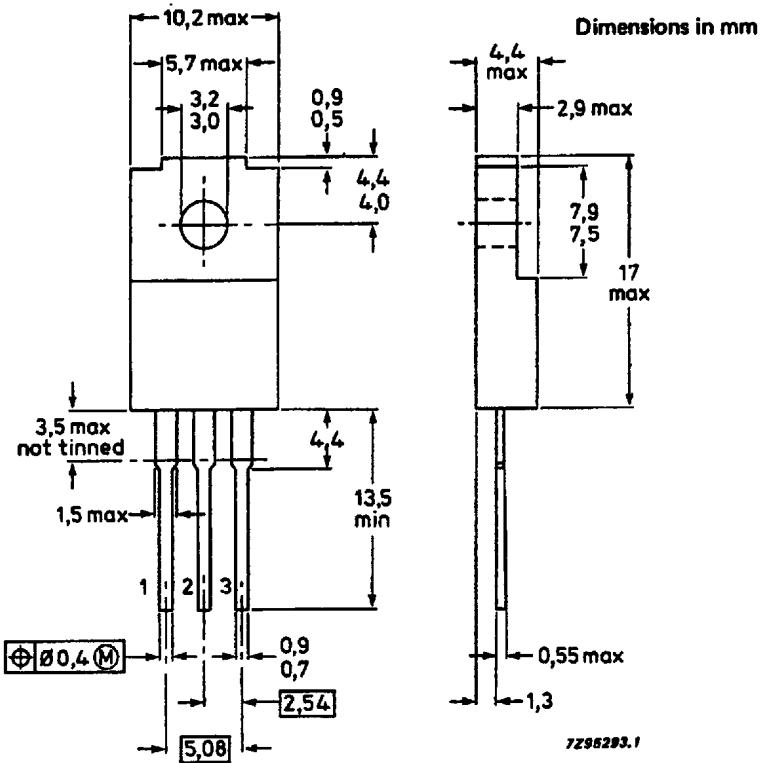
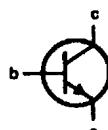


Fig.1 SOT186.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

			BD943F	945F	947F	
Collector-base voltage (open emitter)	V_{CBO}	max.	22	32	45	V
Collector-emitter voltage (open base)	V_{CEO}	max.	22	32	45	V
Emitter-base voltage (open collector)	V_{EBO}	max.		5		V
DC collector current	I_C	max.		5		A
Peak collector current	I_{CM}	max.		8		A
Base current	I_B	max.		1		A
Total power dissipation						
up to $T_h = 25^\circ\text{C}$ (note 1)	P_{tot}	max.		15		W
up to $T_h = 25^\circ\text{C}$ (note 2)	P_{tot}	max.		22		W
Storage temperature range	T_{stg}			-65 to + 150		$^\circ\text{C}$
Junction temperature	T_j	max.		150		$^\circ\text{C}$

THERMAL RESISTANCE

From junction to internal heatsink	$R_{th j-mb} =$	2.93	K/W
From junction to external heatsink (note 1)	$R_{th j-h} =$	7.93	K/W
From junction to external heatsink (note 2)	$R_{th j-h} =$	5.43	K/W

INSULATION

Voltage allowed between all terminals and external heatsink, peak value	V_{insul}	max.	1000	V
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CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current $I_E = 0; V_{CB} = V_{CBOmax}$	I_{CBO}	max.	50	μA	
$I_E = 0; V_{CB} = V_{CBOmax}; T_j = 150^\circ\text{C}$	I_{CBO}	max.	1	mA	
$I_B = 0; V_{CE} = 15 \text{ V}$	BD943F	I_{CEO}	max.	0.1	mA
$I_B = 0; V_{CE} = 20 \text{ V}$	BD945F	I_{CEO}	max.	0.1	mA
$I_B = 0; V_{CE} = 25 \text{ V}$	BD947F	I_{CEO}	max.	0.1	mA
Emitter cut-off current $I_C = 0; V_{EB} = 5 \text{ V}$	I_{EBO}	max.	0.2	mA	

Notes

1. Mounted without heatsink compound and 30 ± 5 newton pressure on centre of envelope.
2. Mounted with heatsink compound and 30 ± 5 newton pressure on centre of envelope.

			BD943F	945F	947F
DC current gain (note 1)					
$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	β_{FE}	min.	25	25	25
$I_C = 500 \text{ mA}; V_{CE} = 1 \text{ V}$	β_{FE}	min.	85	85	85
$I_C = 2 \text{ A}; V_{CE} = 1 \text{ V}$	β_{FE}	max.	475	475	475
$I_C = 3 \text{ A}; V_{CE} = 1 \text{ V}$	β_{FE}	min.	50	50	40
Base-emitter voltage (notes 1 and 2)					
$I_C = 2 \text{ A}; V_{CE} = 1 \text{ V}$	V_{BE}	max.	1.1	1.1	— V
$I_C = 3 \text{ A}; V_{CE} = 1 \text{ V}$	V_{BE}	max.	—	—	1.3 V
Collector-emitter saturation voltage (note 1)					
$I_C = 2 \text{ A}; I_B = 0.2 \text{ A}$	V_{CEsat}	max.	0.5	0.5	— V
$I_C = 3 \text{ A}; I_B = 0.3 \text{ A}$	V_{CEsat}	max.	—	—	0.7 V
Knee voltage (note 1)					
$I_C = 2 \text{ A}; I_B = 20 \text{ mA}$	V_{CEK}	max.		0.8	V
Transition frequency at $f = 1 \text{ MHz}$					
$I_C = 250 \text{ mA}; V_{CE} = 1 \text{ V}$	f_T	min.		3	MHz

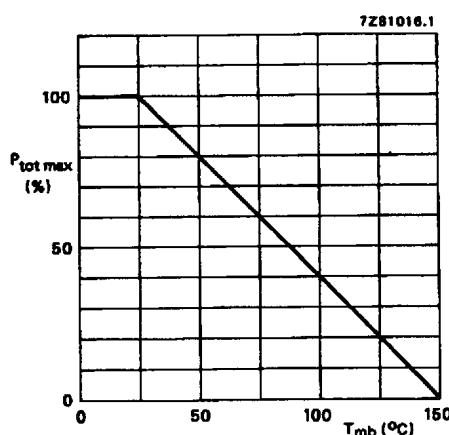
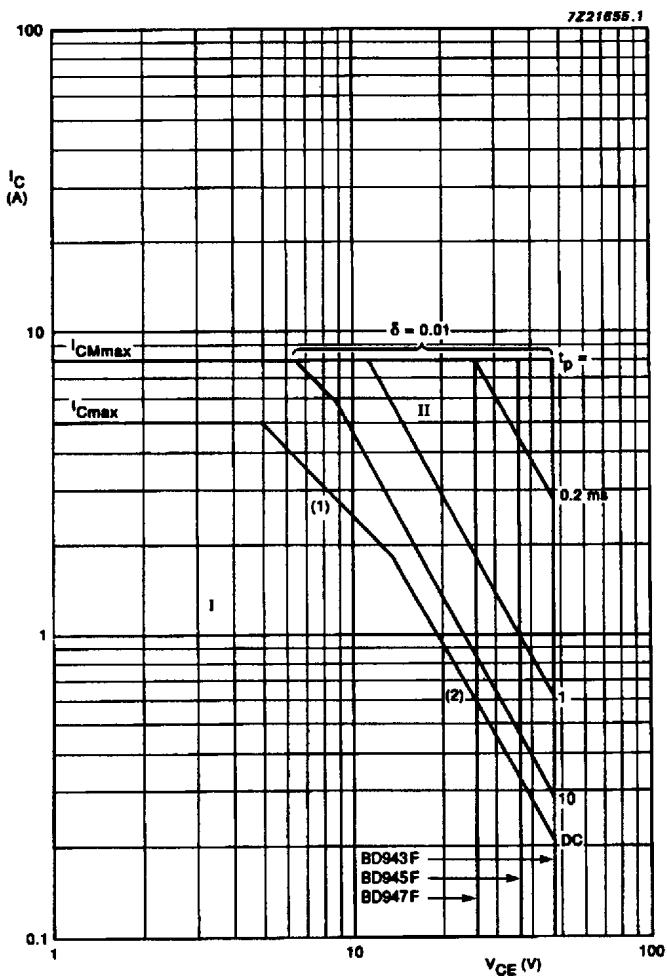


Fig. 2 Power derating curve.

Notes

1. Measured under pulse conditions; $t_p < 300 \mu\text{s}$; $\delta < 2\%$.
2. V_{BE} decreases by about 2.3 mV/K with increasing temperature.



- I Region of permissible DC operation.
 - II Permissible extension for repetitive pulse operation.
 - (1) $P_{tot\ max}$ and $P_{peak\ max}$ lines.
 - (2) Second-breakdown limits.

Fig. 3 Safe Operating Area, $T_{mb} = 25^\circ\text{C}$.

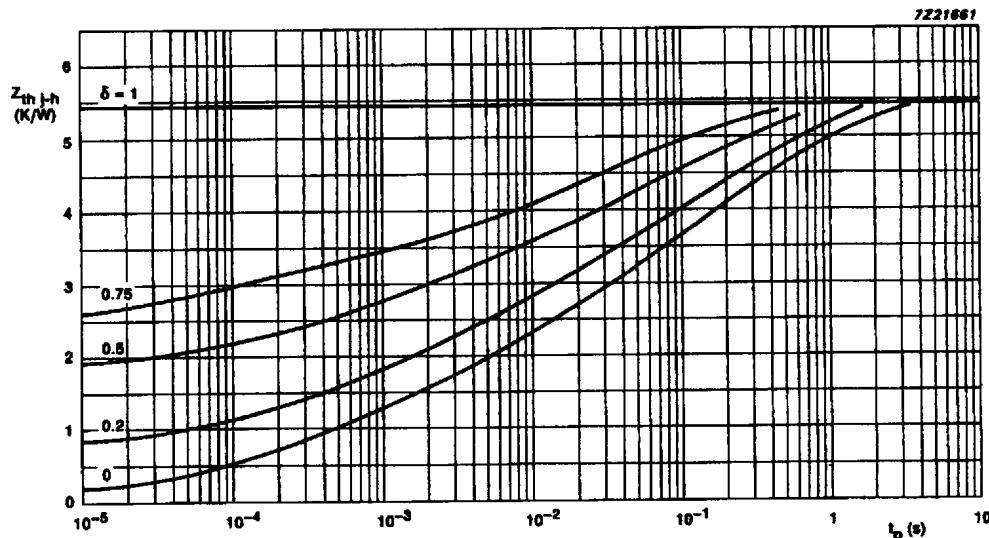
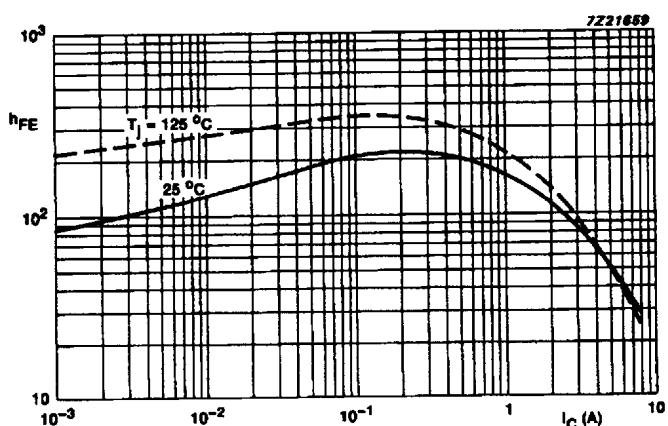


Fig. 4 Pulse power rating chart.

Fig. 5 DC current gain; $V_{CE} = 1 V$; typical values.

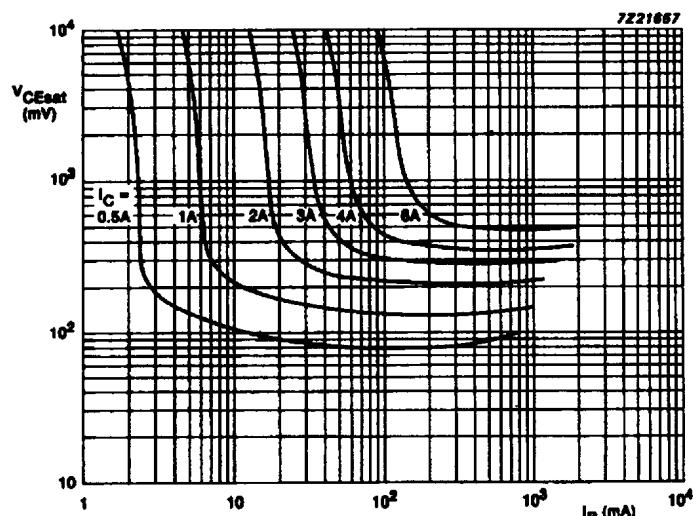


Fig.6 Collector-emitter saturation voltage
as a function of base current $T_h = 25^\circ\text{C}$.